NOA1305

Ambient Light Sensor with I²C Interface and Dark Current Compensation

Description
The NOA1305 ambient light sensor (ALS) is designed for handheld applications and integrates a 16-bit ADC, a 2-wire I²C digital interface, internal clock oscillator and a power down mode. The built in dynamic dark current compensation and precision calibration capability coupled with excellent IR and 50/60 Hz flicker rejection enables highly accurate measurements from very low light levels to full sunlight. The device can support simple count equals lux readings in interrupt-driven or polling modes. The NOA1305 employs proprietary CMOS image sensing technology from ON Semiconductor to provide large signal to noise ratio (SNR) and wide dynamic range (DR) over the entire operating temperature range. The optical filter used with this chip provides a light response similar to that of the human eye.

Features
• Senses Ambient Light and Provides an Output Count Proportional to the Ambient Light Intensity
• Photopic Spectral Response
• Dynamic Dark Current Compensation
• IR Rejection Eliminates Need for Additional IR Photodiode
• Less than 120 μA Active Power Consumption in Normal Operation
• Less than 2 μA Power Dissipation in Power Down Mode
• Interrupt Signal Notifies Host of Significant Intensity Changes
• Wide Operating Voltage Range (2.4 V to 3.6 V)
• Wide Operating Temperature Range (~40°C to 85°C)
• Linear Response Over the Full Operating Range
• Senses Intensity of Ambient Light from 0.165 Lux to Over 100K Lux
• 8 Selectable Integration Times Ranging from 6.25 ms to 800 ms
• No External Components Required
• Built-in 16-bit ADC
• I²C Serial Communication Port Supports Standard and Fast Modes
• Metal Mask Programmable I²C Slave Address Option Available
• These Devices are Pb-Free and are RoHS Compliant

Applications
• Saves Display Power In Applications Such As:
  - Cell Phones, PDAs, MP3 Players, GPS
  - Cameras, Video Recorders
  - Mobile Devices with Displays or Backlit Keypads

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Publication Order Number: NOA1305/D
Table 1. PIN FUNCTION DESCRIPTION

<table>
<thead>
<tr>
<th>Pin</th>
<th>Pin Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VSS</td>
<td>Ground pin.</td>
</tr>
<tr>
<td>2</td>
<td>NC</td>
<td>No connection.</td>
</tr>
<tr>
<td>3</td>
<td>SCL</td>
<td>External I^2^C clock supplied by the I^2^C master. Requires a 1 kΩ pull-up resistor.</td>
</tr>
<tr>
<td>4</td>
<td>SDA</td>
<td>Bi-directional data signal for communications between this device and the I^2^C master. Requires a 1 kΩ pull-up resistor.</td>
</tr>
<tr>
<td>5</td>
<td>INT</td>
<td>Interrupt request to the host. Programmable active state, open-drain output and requires an external 1 kΩ pull-up resistor.</td>
</tr>
<tr>
<td>6</td>
<td>VDD</td>
<td>Power pin.</td>
</tr>
</tbody>
</table>

Table 2. ABSOLUTE MAXIMUM RATINGS

<table>
<thead>
<tr>
<th>Rating</th>
<th>Symbol</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input power supply</td>
<td>VDD</td>
<td>4.0</td>
<td>V</td>
</tr>
<tr>
<td>Input voltage range</td>
<td>V^in^</td>
<td>–0.3 to VDD + 0.2</td>
<td>V</td>
</tr>
<tr>
<td>Output voltage range</td>
<td>V^out^</td>
<td>–0.3 to VDD + 0.2</td>
<td>V</td>
</tr>
<tr>
<td>Maximum Junction Temperature</td>
<td>T^J(max)^</td>
<td>85</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>T^STG^</td>
<td>–40 to 85</td>
<td>°C</td>
</tr>
<tr>
<td>ESD Capability, Human Body Model (Note 1)</td>
<td>ESD^HBM^</td>
<td>2</td>
<td>kV</td>
</tr>
<tr>
<td>ESD Capability, Charged Device Model (Note 1)</td>
<td>ESD^CDM^</td>
<td>750 (corner pins), 500 (center pins)</td>
<td>V</td>
</tr>
<tr>
<td>ESD Capability, Machine Model (Note 1)</td>
<td>ESD^MM^</td>
<td>200</td>
<td>V</td>
</tr>
<tr>
<td>Moisture Sensitivity Level</td>
<td>MSL</td>
<td>5</td>
<td>–</td>
</tr>
<tr>
<td>Lead Temperature Soldering (Note 2)</td>
<td>T^SLD^</td>
<td>260</td>
<td>°C</td>
</tr>
</tbody>
</table>

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. This device incorporates ESD protection and is tested by the following methods:
   - ESD Human Body Model tested per EIA/JESD22–A114
   - ESD Charged Device Model tested per ESD–STM5.3.1–1999
   - ESD Machine Model tested per EIA/JESD22–A115
   - Latchup Current Maximum Rating: ≤ 100 mA per JEDEC standard: JESD78

2. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D
Table 3. OPERATING RANGES

<table>
<thead>
<tr>
<th>Rating</th>
<th>Symbol</th>
<th>Standard Mode</th>
<th>Fast Mode</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power supply voltage</td>
<td>VDD</td>
<td>2.4</td>
<td>3.6</td>
<td>V</td>
</tr>
<tr>
<td>Power supply current</td>
<td>IDD</td>
<td>120</td>
<td>120</td>
<td>µA</td>
</tr>
<tr>
<td>Quiescent supply current (Note 3)</td>
<td>IDD_{qe}</td>
<td>2.0</td>
<td>2.0</td>
<td>µA</td>
</tr>
<tr>
<td>Low level input voltage (VDD related input levels)</td>
<td>VIL</td>
<td>−0.5</td>
<td>0.3 VDD</td>
<td></td>
</tr>
<tr>
<td>High level input voltage (VDD related input levels) (Note 4)</td>
<td>VIL</td>
<td>0.7 VDD</td>
<td>VDD + 0.5</td>
<td>V</td>
</tr>
<tr>
<td>Hysteresis of Schmitt trigger inputs (VDD &gt; 2 V)</td>
<td>V_{hys}</td>
<td>N/A</td>
<td>N/A</td>
<td></td>
</tr>
<tr>
<td>Low level output voltage (open drain) at 3 mA sink current (VDD &gt; 2 V)</td>
<td>VOL</td>
<td>0</td>
<td>0.4</td>
<td></td>
</tr>
<tr>
<td>Output low current (VOL=0.4 V)</td>
<td>IOL</td>
<td>3</td>
<td>N/A</td>
<td>mA</td>
</tr>
<tr>
<td>Output low current (VOL=0.6 V)</td>
<td>IOL</td>
<td>N/A</td>
<td>6</td>
<td>mA</td>
</tr>
<tr>
<td>Output fall time from V_{Hmin} to V_{Lmax} with a bus capacitance, C_b from 10 pF to 400 pF (Note 4)</td>
<td>t_{of}</td>
<td>–</td>
<td>250</td>
<td>20+0.1C_b 250 ns</td>
</tr>
<tr>
<td>Pulse width of spikes which must be suppressed by the input filter</td>
<td>t_{SP}</td>
<td>N/A</td>
<td>N/A</td>
<td>0</td>
</tr>
<tr>
<td>Input current of IO pin with an input voltage between 0.1 VDD and 0.9 VDD</td>
<td>I_{I}</td>
<td>−10</td>
<td>10</td>
<td></td>
</tr>
<tr>
<td>Capacitance on IO pin</td>
<td>C_{I}</td>
<td>–</td>
<td>10</td>
<td>pF</td>
</tr>
<tr>
<td>Operating free–air temperature range</td>
<td>TA</td>
<td>−40</td>
<td>85</td>
<td>°C</td>
</tr>
</tbody>
</table>

3. Current dissipation when a software Power Down command is sent to the device.
4. C_b = capacitance of one bus line, maximum value of which including all parasitic capacitances should be less than 400 pF.

Table 4. ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, these specifications apply over VDD = 3.3 V, −40°C < TA < 85°C) (Note 5)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Standard Mode</th>
<th>Fast Mode</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>SCL clock frequency</td>
<td>f_{SCL}</td>
<td>0</td>
<td>100</td>
<td>kHz</td>
</tr>
<tr>
<td>Hold time for START condition. After this period, the first clock pulse is generated.</td>
<td>t_{HD;STA}</td>
<td>4.0</td>
<td>–</td>
<td>0.6</td>
</tr>
<tr>
<td>Low period of SCL clock</td>
<td>t_{LOW}</td>
<td>4.7</td>
<td>–</td>
<td>1.3</td>
</tr>
<tr>
<td>High period of SCL clock</td>
<td>t_{HIGH}</td>
<td>4.0</td>
<td>–</td>
<td>0.6</td>
</tr>
<tr>
<td>Set–up time for a repeated START condition</td>
<td>t_{SU;STA}</td>
<td>4.7</td>
<td>–</td>
<td>0.6</td>
</tr>
<tr>
<td>Data hold time for I²C–bus devices</td>
<td>t_{HD;DAT_d}</td>
<td>0</td>
<td>3.45</td>
<td>0</td>
</tr>
<tr>
<td>Data set–up time</td>
<td>t_{SU;DAT}</td>
<td>250</td>
<td>–</td>
<td>100</td>
</tr>
<tr>
<td>Rise time of both SDA and SCL (Note 6)</td>
<td>t_{r}</td>
<td>–</td>
<td>1000</td>
<td>20 + 0.1C_b 300</td>
</tr>
<tr>
<td>Fall time of both SDA and SCL (Note 6)</td>
<td>t_{f}</td>
<td>–</td>
<td>300</td>
<td>20 + 0.1C_b 300</td>
</tr>
<tr>
<td>Set–up time for STOP condition</td>
<td>t_{SU;STO}</td>
<td>4.0</td>
<td>–</td>
<td>0.6</td>
</tr>
<tr>
<td>Bus free time between STOP and START condition</td>
<td>t_{BUF}</td>
<td>4.7</td>
<td>–</td>
<td>1.3</td>
</tr>
<tr>
<td>Capacitive load for each bus line</td>
<td>C_{B}</td>
<td>–</td>
<td>400</td>
<td>–</td>
</tr>
<tr>
<td>Noise margin at the low level for each connected device (including hysteresis)</td>
<td>V_{nL}</td>
<td>0.1 VDD</td>
<td>–</td>
<td>0.1 VDD</td>
</tr>
<tr>
<td>Noise margin at the high level for each connected device (including hysteresis)</td>
<td>V_{nH}</td>
<td>0.2 VDD</td>
<td>–</td>
<td>0.2 VDD</td>
</tr>
</tbody>
</table>

5. Refer to Figure 3 for more information on AC characteristics
6. The rise time and fall time are measured with a pull–up resistor R_p = 1 kΩ and C_b of 400 pF (including all parasitic capacitances).
Table 5. OPTICAL CHARACTERISTICS
(Unless otherwise specified, these specifications are for VDD = 3.3 V, TA = 25°C, TINT = 200 ms)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Symbol</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Irradiance responsivity</td>
<td>λp (see Figure 5)</td>
<td>R_e</td>
<td>545</td>
<td></td>
<td></td>
<td>nM</td>
</tr>
<tr>
<td>Illuminance responsivity</td>
<td>White LED Source:</td>
<td>R_{v100}</td>
<td>154</td>
<td></td>
<td></td>
<td>Counts</td>
</tr>
<tr>
<td></td>
<td>Ev = 100 lux (see Figure 6)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>White LED source:</td>
<td>R_{v1000}</td>
<td>1543</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Ev = 1000 lux (see Figure 6)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Dark responsivity</td>
<td>Ev = 0 lux (see Figure 6)</td>
<td>I_{DARK}</td>
<td>0</td>
<td></td>
<td></td>
<td>Counts</td>
</tr>
</tbody>
</table>

Figure 3. AC Characteristics
TYPICAL CHARACTERISTICS

**Figure 4. Spectral Response**

- **WAVELENGTH (nm)**
  - 900
  - 800
  - 700
  - 600
  - 500
  - 400
  - 300
  - 200
  - 100

- **OUTPUT COUNTS (Normalized)**
  - 1.0
  - 0.9
  - 0.8
  - 0.7
  - 0.6
  - 0.5
  - 0.4
  - 0.3
  - 0.2
  - 0.1
  - 0.0

**Figure 5. Illumination Response to Various Light Sources**

- **Ev (lux)**
  - 1200
  - 1000
  - 800
  - 600
  - 400
  - 200
  - 0

- **Temperature (°C)**
  - 2000
  - 1600
  - 1200
  - 800
  - 400
  - 0

- **RATIO**
  - 2.0
  - 1.5
  - 1.0
  - 0.5
  - 0.0

**Figure 6. Output Counts vs. Ev**

- **Ev (lux)**
  - 0
  - 200
  - 400
  - 600
  - 800
  - 1000
  - 1200

- **OUTPUT COUNTS**
  - 2000
  - 1600
  - 1200
  - 800
  - 400
  - 0

**Figure 7. Output Counts vs. Temperature (100 lux)**

- **Temperature (°C)**
  - -60
  - -40
  - -20
  - 0
  - 20
  - 40
  - 60
  - 80
  - 100

- **VDD = 3.3 V**

**Figure 8. Output Counts vs. Angle (End View, Normalized)**

- **Figure 9. Output Counts vs. Angle (Side View, Normalized)**
**TYPICAL CHARACTERISTICS**

**Figure 10. Output Counts vs. Temperature**
(0 lux)

**Figure 11. Output Counts vs. Supply Voltage**
(100 lux)

**Figure 12. Supply Current vs. Temperature**
(100 lux)

**Figure 13. Supply Current vs Supply Voltage**
(100 lux)

**Figure 14. Maximum Value of RP (in kΩ) as a function of Bus Capacitance (in pF)**

**Figure 15. SDA Fall Time (t_f)**

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http://onsemi.com

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## Ambient Light Sensor Architecture

The NOA1305 employs a sensitive photo diode fabricated in ON Semiconductor’s standard CMOS process technology. The major components of this sensor are as shown in Figure 2. The photons which are to be detected pass through an ON Semiconductor proprietary color filter limiting extraneous photons and thus performing as a band pass filter on the incident wave front. The filter only transmits photons in the visible spectrum which are primarily detected by the human eye. The photo response of this sensor is as shown in Figure 5.

The ambient light signal detected by the photo diode is converted to digital signal using a variable slope integrating ADC with a resolution of 16−bits, unsigned. The ADC value is provided to the control block connected to the I2C interface block.

Equation 1 shows the relationship of output counts \( C_{nt} \) as a function of integration constant \( I_k \), integration time \( T_{int} \) (in seconds) and the intensity of the ambient light, \( I_L \) (in lux), at room temperature (25°C):

\[
I_L = C_{nt}/(I_k \times T_{int}) \tag{eq. 1}
\]

Where:
- \( I_k = 7.7 \) (for White LED Source)

For example let:
- \( C_{nt} = 1000 \)
- \( T_{int} = 200 \text{ mS} \)

Intensity of ambient light, \( I_L \) (in lux):

\[
I_L = 1000/(7.7 \times 200 \text{ mS}) \tag{eq. 2}
\]

\( I_L = 649 \text{ lux} \)

### Modes of Operation

The NOA1305 can be placed in any of the following modes of operation by programming registers over the I2C bus:

1. Interrupt driven mode
2. Polling mode
3. Power−down mode

In the interrupt driven mode, once the NOA1305 is configured, no I2C activity is necessary until the ambient light intensity goes above the value programmed in the interrupt threshold register. When this occurs, the device signals an interrupt on the INT pin. Then it is up to the I2C master host to read the ALS count from the device.

In polling mode, interrupts are typically disabled, but the NOA1305 continuously takes measurements and the I2C master host reads out the most recent count whenever it desires to do so, typically in a timed repeat loop.

In power−down mode, the NOA1305 stops taking ambient light measurements and powers down most of the internal circuitry and the INT pin is deactivated. Power is maintained to preserve the register values (static memory) and a portion of the I2C remains active to monitor for a power−on command to the NOA1305.

### I2C Interface

The NOA1305 acts as an I2C slave device and supports single register read and write operations, in addition to block read and block write operations. All data transactions on the bus are 8 bits long. Each data byte transmitted is followed by an acknowledge bit. Data is transmitted with the MSB first.

Figure 16 shows an I2C write operation. Write transactions begin with the master sending an I2C start sequence followed by the seven bit slave address (NOA1305 = 0x39) and the write(0) command bit. The NOA1305 will acknowledge this byte transfer with an appropriate ACK. Next the master will send the 8 bit register address to be written to. Again the NOA1305 will acknowledge reception with an ACK. Finally, the master will begin sending 8 bit data segment(s) to be written to the NOA1305 register bank. The NOA1305 will send an ACK after each byte and increment the address pointer by one in preparation for the next transfer. Write transactions are terminated with either an I2C STOP or with another I2C START (repeated START).

![Figure 16. I2C Write Command](http://onsemi.com)
Figure 17 shows the most basic I2C read command sequence sent by the master to the slave device. The sequence consists of a complete I2C write command which sets the address pointer in preparation for the I2C read command since the read command itself does not include a register address. When reading from a read only data register in the NOA1305 it is acceptable to write a 0 to the register in order to update the address pointer, but the 0 does not actually over-write the value in the data register.

Once the I2C write command is completed, the master sends an I2C start sequence followed by the seven bit slave address (NOA1305 = 0x39) and the read (1) command bit. The NOA1305 will acknowledge this byte transfer with an appropriate ACK. The NOA1305 will then begin shifting out data from the register just addressed. If the master wishes to receive more data (next register address), it will ACK the slave at the end of the 8 bit data transmission, and the slave will respond by sending the next byte, and so on. To signal the end of the read transaction, the master will send a NACK bit at the end of a transmission followed by an I2C STOP.

Rise and Fall Time of SDA (Output)

Proper operation of the I2C bus depends on keeping the bus capacitance low and selecting suitable pull-up resistor values. Figure 15 shows the fall time on SDA in output mode under maximum load conditions. The measurement set-up is shown in Figure 18. Figure 14 shows the maximum value of the pull-up resistor ($R_P$) as a function of the I2C data bus capacitance.
NOA1305 Data Registers

NOA1305 operation is observed and controlled by internal data registers read from and written to via the external I²C interface. Registers are listed in Table 6. Default values are set on initial power up.

Table 6. NOA1305 DATA REGISTERS (Note 7)

<table>
<thead>
<tr>
<th>Address</th>
<th>Register</th>
<th>Type</th>
<th>Value (binary)</th>
<th>Description</th>
<th>Default (binary)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0x00</td>
<td>POWER_CONTROL</td>
<td>RW</td>
<td>0000 0000</td>
<td>Power Down</td>
<td>0000 1000</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 1000</td>
<td>Power On</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 1001</td>
<td>Test Mode 1 (reserved)</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 1010</td>
<td>Test Mode 2 (fixed output 0x5555)</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 1011</td>
<td>Test Mode 3 (fixed output 0xAAAA)</td>
<td></td>
</tr>
<tr>
<td>0x01</td>
<td>RESET</td>
<td>RW</td>
<td>0001 0000</td>
<td>Reset ALS data. Resets to 0000</td>
<td>0000 0000</td>
</tr>
<tr>
<td>0x02</td>
<td>INTEGRATION_TIME</td>
<td>RW</td>
<td>0000 0000</td>
<td>800 ms continuous measurement</td>
<td>0000 0010</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0001</td>
<td>400 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0010</td>
<td>200 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0011</td>
<td>100 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0100</td>
<td>50 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0101</td>
<td>25 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0110</td>
<td>12.5 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0111</td>
<td>6.25 ms continuous measurement</td>
<td></td>
</tr>
<tr>
<td>0x03</td>
<td>INT_SELECT</td>
<td>RW</td>
<td>0000 0001</td>
<td>L → H</td>
<td>0000 0011</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0010</td>
<td>H → L</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>0000 0011</td>
<td>Inactive, always H</td>
<td></td>
</tr>
<tr>
<td>0x04</td>
<td>INT_THRESH_LSB</td>
<td>RW</td>
<td>XXXX XXXX</td>
<td>Interrupt threshold, least significant bits</td>
<td>0000 0000</td>
</tr>
<tr>
<td>0x05</td>
<td>INT_THRESH_MSB</td>
<td>RW</td>
<td>XXXX XXXX</td>
<td>Interrupt threshold, most significant bits</td>
<td>0000 1000</td>
</tr>
<tr>
<td>0x06</td>
<td>ALS_DATA_LSB</td>
<td>R</td>
<td>XXXX XXXX</td>
<td>ALS measurement data, least significant bits</td>
<td>0000 0000</td>
</tr>
<tr>
<td>0x07</td>
<td>ALS_DATA_MSB</td>
<td>R</td>
<td>XXXX XXXX</td>
<td>ALS measurement data, most significant bits</td>
<td>0000 0000</td>
</tr>
<tr>
<td>0x08</td>
<td>DEVICE_ID_LSB</td>
<td>R</td>
<td>0001 1001</td>
<td>Device ID value, least significant bits</td>
<td>0001 1001</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>(1305 decimal, 0x0519 hex)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>0x09</td>
<td>DEVICE_ID_MSB</td>
<td>R</td>
<td>0000 0101</td>
<td>Device ID value, most significant bits</td>
<td>0000 0101</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>(1305 decimal, 0x0519 hex)</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

7. Writing a value other than those specified for registers 0x00, 0x01, 0x02, 0x03 will cause the specified default value to be written instead.
POWER_CONTROL Register (0x00)
The POWER_CONTROL register is used to power the device up and down via software control. By default this device powers up in the power ON mode. To reduce power consumption, the NOA1305 can be powered down at any time by writing 0x00 to this register.

To power up the device, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x00 for the POWER_CONTROL register address
4. Issue 0x08 to put the device in the power on state
5. Issue Stop command

After applying power to the device or after issuing a power on command, stable ALS_DATA and INT signal may not be available for the first three integration times. For example with a default of 200 ms integration time, the I2C master should wait at least 600 ms before accessing this device.

To power down the device, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x00 for the POWER_CONTROL register address
4. Issue 0x00 to put the device in the power down state
5. Issue Stop command

INTEGRATION_TIME Register (0x02)
The INTEGRATION_TIME register controls the integration time of the ambient light sensor which directly affects the sensitivity.

To set the integration time, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x02 for the INTEGRATION_TIME register address
4. Issue 0x02 to set the integration time to 200 ms (for example)
5. Issue Stop command

INT_SELECT Register (0x03)
The INT_SELECT register controls the polarity of the interrupt pin INT and enables or disables interrupts on that pin.

To specify low to high transitions on INT to signal an interrupt, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x01 to specify low to high signaling on INT
5. Issue Stop command

To specify low to high transitions on INT to signal an interrupt, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x02 to specify high to low signaling on INT
5. Issue Stop command

Disabling interrupts causes the INT pin to be held in the open–drain or high state. To disable interrupts completely on the INT pin, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x03 for the INT_SELECT register address
4. Issue 0x03 to disable interrupts on INT
5. Issue Stop command

INT_THRESH_LSB and INT_THRES_MSB Registers (0x04, 0x05)
The INT_THRESH register specifies an ambient light threshold value for signaling interrupts on the INT pin. The INT_THRESH register is 16–bits wide to match the 16–bit ALS_DATA register and is accessed over the I2C bus as two 8–bit registers for the least and most significant bits (LSB and MSB). On any measurement cycle where the ALS_DATA intensity count exceeds the INT_THRESH value, the INT pin will become active and will remain active until a measurement cycle where the count is less than or
equal to the threshold (and provided the INT pin is enabled, see INT_SELECT register).

Changing the INT_THRESH register value can cause the INT pin to change immediately if the ALS_DATA to INT_THRESH comparison changes.

Powering down the device will cause the INT pin to become inactive.

To program a value into the INT_THRESH register, use the following write command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
3. Issue 0x04 for the INT_THRES_LSB register address
4. Issue the 8–bit LSB value
5. Issue Stop command
6. Issue Start command
7. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by write–bit 0)
8. Issue 0x05 for the INT_THRES_MSB register address
9. Issue the 8–bit MSB value
10. Issue Stop command

After a power–down and power–on sequence, wait at least three integration times for the data to stabilize, before accessing any ALS_DATA values from NOA1305.

ALS_DATA_LSB and ALS_DATA_MSB Registers (0x06, 0x07)
The ALS_DATA register holds the ambient light intensity count from the most recent measurement. The ALS_DATA register is 16–bits wide and is accessed from the I2C bus as two 8–bit registers for the least and most significant bits (LSB and MSB).

To read the ALS_DATA register, use the following read command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by read–bit 1)
3. Issue 0x06 for the ALS_DATA_LSB register address
4. Issue Start command
5. Issue 0x73 (lower seven bits of I2C slave address 0x39 followed by read–bit 1)
6. Read the ALS_DATA_LSB byte
7. Read the ALS_DATA_MSB byte
8. Issue Stop command

DEVICE_ID_LSB and DEVICE_ID_MSB Registers (0x08, 0x09)
The DEVICE_ID register is a pre–programmed register that describes the device. For the NOA1305, the register holds the decimal value of 1305 (0x0519). The DEVICE_ID register is 16–bits wide and is accessed from the I2C bus as two 8–bit registers for the least and most significant bits (LSB and MSB).

To read the DEVICE_ID register, use the following read command sequence:
1. Issue Start command
2. Issue 0x72 (lower seven bits of I2C slave address 0x39 followed by read–bit 0)
3. Issue 0x08 for the DEVICE_ID_LSB register address
4. Issue Start command
5. Issue 0x73 (lower seven bits of I2C slave address 0x39 followed by read–bit 1)
6. Read the DEVICE_ID_LSB byte
7. Read the DEVICE_ID_MSB byte
8. Issue Stop command
Example Programming Sequence

The following pseudo code configures the NOA1305 ambient light sensor and then runs it in an interrupt driven mode. When the controller receives an interrupt, it reads the ALS_Data from the device, sets a flag and then waits for the main polling loop to respond to the ambient light change.

external subroutine I2C_Read_Byte (I2C_Address, Data_Address);
external subroutine I2C_Read_Block (I2C_Address, Data_Start_Address, Count, Memory_Map);
external subroutine I2C_Write_Byte (I2C_Address, Data_Address, Data);
external subroutine I2C_Write_Block (I2C_Address, Data_Start_Address, Count, Memory_Map);

subroutine Initialize_ALS () {
    MemBuf[0x00] = 0x08;   // POWER_CONTROL assert Power On
    MemBuf[0x01] = 0x10;   // RESET assert reset
    MemBuf[0x02] = 0x02;   // INTEGRATION_TIME select 200ms
    MemBuf[0x03] = 0x01;   // INT_SELECT select Low to High
    MemBuf[0x04] = 0xFF;   // INT_THRESH_LSB
    MemBuf[0x05] = 0x8F;   // INT_THRESH_MSB
    I2C_Write_Block (I2CAddr, 0x00, 6, MemBuf);
}

subroutine I2C_Interupt_Handler () {
    // Retrieve and store the ALS data
    ALS_Data_LSB = I2C_Read_Byte (I2CAddr, 0x06);
    ALS_Data_MSB = I2C_Read_Byte (I2CAddr, 0x07);
    NewALS = 0x01;
}

subroutine main_loop () {
    I2CAddr = 0x39;
    NewALS = 0x00;
    Initialize_ALS ();
    loop {
        // Do some other polling operations
        if (NewALS == 0x01) {
            NewALS = 0x00;
            // Do some operations with ALS_Data
        }
    }
}
NOA1305

PACKAGE DIMENSIONS

CUDFN6, 2x2
CASE 505AD–01
ISSUE B

PIN ONE REFERENCE

TOP VIEW

DETAIL A

SIDE VIEW

SEATING PLANE

END VIEW

MOUNTING FOOTPRINT

BOTTOM VIEW

NOTES:
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION B APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIMENSIONS: MILLIMETERS

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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